



## Technological Advances in Seismic Data Processing and Imaging

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### Message from the Guest Editors

Dear Colleagues,

Seismic exploration is a method with deeper exploration capabilities and higher resolution than potential geophysical methods and has been widely used in the fields of oil and gas exploration, mineral exploration, engineering, and environmental exploration. Seismic data processing includes many conventional steps such as static correction, denoising, deconvolution, migration, and multiple eliminations, all of which play an important role in improving the final imaging quality. This Special Issue will focus on the development of advanced seismic data processing and imaging technologies and their successful application. It also welcomes technological development on passive seismic and surface wave-related development. Seismic data processing with deep learning and parallel computing is also considered in this issue.

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## Message from the Editor-in-Chief

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